



# Product Change Notification

**Change Notification #:** 118194-00  
**Change Title:** Select Intel® Compute Module HNS2600BP Family  
PCN 118194-00, Product Design,  
Design Tool Improvement for Plastic Air Duct Cover  
**Date of Publication:** April 06, 2021

## Key Characteristics of the Change:

Product Design

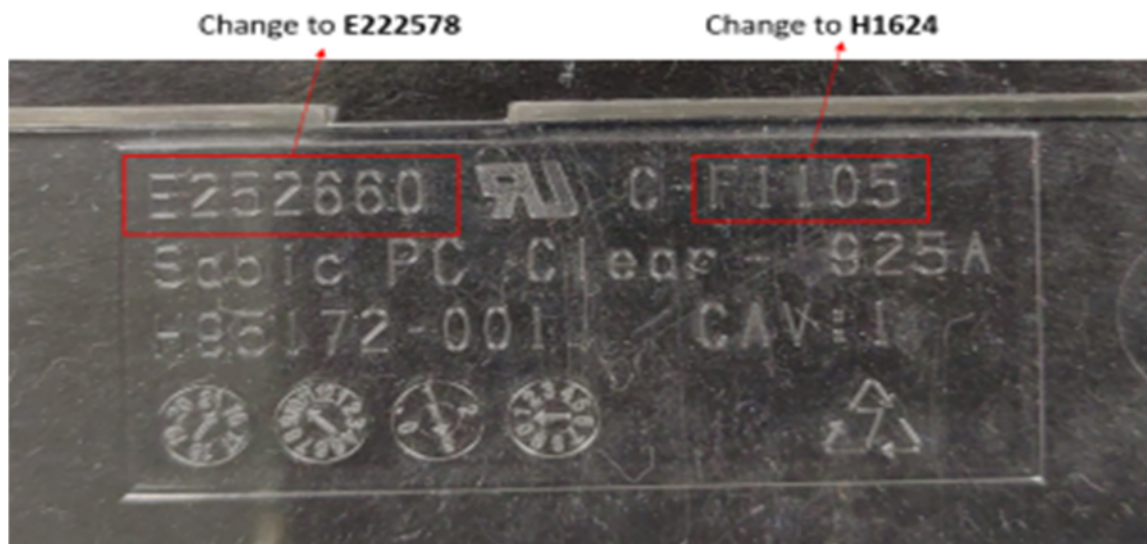
## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material: *</b>	April 26, 2021
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is implementing an improvement to the tool used for manufacturing plastic air duct cover, leading to a change in the UL numbers as illustrated below:



## Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason, Intel recommends that the customer perform a standard level of evaluation.

## Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA
Intel® Compute Module HNS2600BPQ24R	HNS2600BPQ24R	986120	K36259-004	K36259-005

## PCN Revision History:

**Date of Revision:**

April 06, 2021

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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